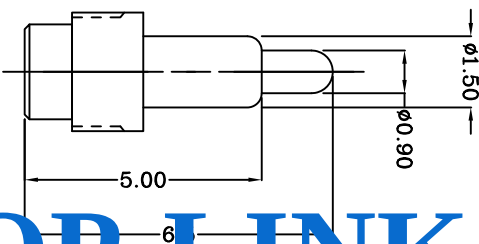
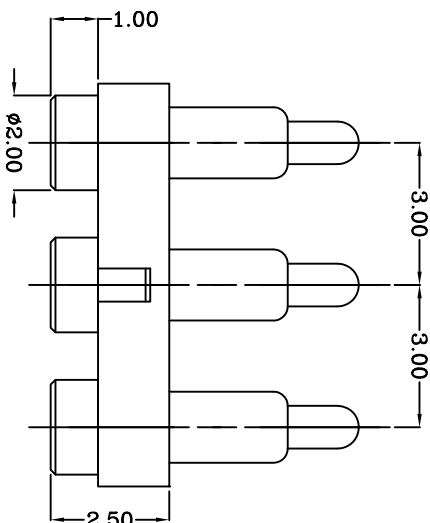
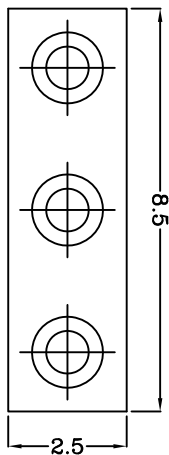
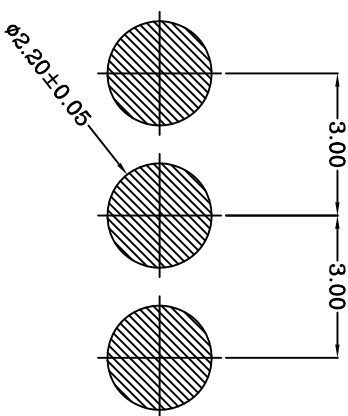


DWG NO.
C-110227



TOP-LINK



Recommended PCB Layout
Recommended solder paste thickness is 0.10 mm

Notes:

1 Material, Housing: PA 4,6 (30% Glass Filled)
Color Black.

2 Mechanical demands:

Plating Plunger: 0.4um Au over 1.4um Ni
Plating Body: 0.1um Au over 1.4um Ni.

LDC					HANDLE: 11	NAME	PGGD 3P		
-		update remark		8007/18/21			PGC-1.5-6.5-R-3P-3.0PH		
DIST		REVISION RECORD	APVD	DATE	SCALE	A4	DWG NO. C-110227	SHEET 1 OF 1	REV B
-					1:1				

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED				MATL		HT TR	—	FIN	— 
0	= ±			DWN		APVD			
0.0	= ±0.15			Benny		Lansing			
0.00	= ±0.10			CHK		REL			
0.000	= ±			Andy					
ANGLE: ±1°									
SURF TEXTURE: 32/ 				NAME					
REMOVE BURRS, BREAK SHARP EDGES R0.05 MAX DO NOT SCALE PRINT				PGGD 3P PGC-1.5-6.5-R-3P-3.0PH  Top-Link Electronics Ltd.					
SCALE		A4	DWG NO.	C-110227	SHEET		1 OF 1	REV	B

110227-3
PART NUMBER

USED ON